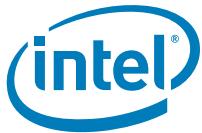


Intel® Core™ i7-900 Desktop Processor Extreme Edition Series and Intel® Core™ i7-900 Desktop Processor Series on 32-nm Process

Datasheet, Volume 2

July 2010



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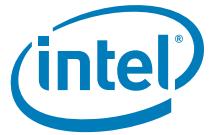
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Revision History

Revision	Description	Date
-001	Initial release.	March 2010
-002	Added the Intel® Core™ i7-900 desktop processor series on 32-nm process.	July 2010

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1 Introduction

The Intel® Core™ i7-900 desktop processor Extreme Edition series and Intel® Core™ i7-900 desktop processor series on 32-nm process are the next generation desktop/workstation processors based on the Intel® Core™ i7-900 desktop processor series architecture, and using 32 nm process technology. The Intel® Core™ i7-900 desktop processor Extreme Edition series and Intel® Core™ i7-900 desktop processor series on 32-nm process upgrades Intel® Core™ i7-900 desktop processor series platforms, and provides the following new features and capabilities:

- Up to 6-core operation (up to 12 threads per socket with Intel Hyper-Threading Technology)
- 12 MB of shared Last-Level Cache
- Advanced Encryption Standard — New Instructions (AES-NI)

This document provides Intel® Core™ i7-900 desktop processor Extreme Edition series and Intel® Core™ i7-900 desktop processor series on 32-nm process content, and is intended to supplement the functional descriptions and register documentation found in the *Intel® Core™ i7 Processor Extreme Edition and Intel® Core™ i7 Processor Datasheet, Volume 2*.

1.1 References

Material and concepts available in the following documents may be beneficial when reading this document.

Table 1-1. References

Document	Location
<i>Intel® Core™ i7-900 Desktop Processor Extreme Edition Series and Intel® Core™ i7-900 Desktop Processor Series on 32-nm Process Datasheet, Volume 1</i>	http://download.intel.com/design/processor/datashts/323252.pdf
<i>Intel® Core™ i7-900 Desktop Processor Extreme Edition Series and Intel® Core™ i7-900 Desktop Processor Series on 32-nm Process Specification Update</i>	http://www.intel.com/Assets/PDF/specupdate/323254.pdf
<i>Intel® Core™ i7-900 Desktop Processor Extreme Edition and Intel® Core™ i7-900 Desktop Processor Series Datasheet, Volume 2</i>	http://download.intel.com/design/processor/datashts/320835.pdf
<i>Intel® 64 and IA-32 Architectures Software Developer's Manual</i> <ul style="list-style-type: none"> • <i>Volume 1: Basic Architecture</i> • <i>Volume 2A: Instruction Set Reference, A-M</i> • <i>Volume 2B: Instruction Set Reference, N-Z</i> • <i>Volume 3A: System Programming Guide, Part 1</i> • <i>Volume 3B: Systems Programming Guide, Part 2</i> 	http://www.intel.com/products/processor/manuals/

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2 Register Description

The processor supports PCI configuration space accesses using the mechanism denoted as Configuration Mechanism in the PCI specification as defined in the *PCI Local Bus Specification*, as well as the PCI Express enhanced configuration mechanism as specified in the *PCI Express Base Specification*. All the registers are organized by bus, device, function, etc. as defined in the *PCI Express Base Specification*. All processor registers appear on the PCI bus assigned for the processor socket. Bus number is derived by the maximum bus range setting and processor socket number. All multi-byte numeric fields use “little-endian” ordering (that is, lower addresses contain the least significant parts of the field).

2.1 Register Terminology

Registers and register bits are assigned one or more of the following attributes. These attributes define the behavior of register and the bit(s) that are contained within. All bits are set to Reset values by hard reset. Sticky bits retain their states between hard resets.

Term	Description
RO	Read Only. If a register bit is read only, the hardware sets its state. The bit may be read by software. Writes to this bit have no effect.
WO	Write Only. The register bit is not implemented as a bit. The write causes some hardware event to take place.
RW	Read/Write. A register bit with this attribute can be read and written by software.
RC	Read Clear: The bit or bits can be read by software, but the act of reading causes the value to be cleared.
RCW	Read Clear/Write: A register bit with this attribute will get cleared after the read. The register bit can be written.
RW1C	Read/Write 1 Clear. A register bit with this attribute can be read or cleared by software. In order to clear this bit, a one must be written to it. Writing a zero will have no effect.
RWOC	Read/Write 0 Clear. A register bit with this attribute can be read or cleared by software. In order to clear this bit, a zero must be written to it. Writing a one will have no effect.
RW1S	Read/Write 1 Set: A register bit can be either read or set by software. To set this bit, a one must be written to it. Writing a zero to this bit has no effect. Hardware will clear this bit.
RWOS	Read/Write 0 Set: A register bit can be either read or set by software. To set this bit, a zero must be written to it. Writing a one to this bit has no effect. Hardware will clear this bit.
RWL	Read/Write/Lock. A register bit with this attribute can be read or written by software. Hardware or a configuration bit can lock the bit and prevent it from being updated.
RWO	Read/Write Once. A register bit with this attribute can be written to only once after power up. After the first write, the bit becomes read only. This attribute is applied on a bit by bit basis. For example, if the RWO attribute is applied to a 2-bit field, and only one bit is written, then the written bit cannot be rewritten (unless reset). The unwritten bit, of the field, may still be written once. This is a special case of RWL.
RRW	Read/Restricted Write. This bit can be read and written by software. However, only supported values will be written. Writes of non-supported values will have no effect.
L	Lock. A register bit with this attribute becomes Read Only after a lock bit is set.
Reserved	Reserved Bit. This bit is reserved for future expansion and must not be written. The <i>PCI Local Bus Specification</i> , Revision 2.2 requires that reserved bits must be preserved. Any software that modifies a register that contains a reserved bit is responsible for reading the register, modifying the desired bits, and writing back the result.



Term	Description
Reserved Bits	Some of the processor registers described in this section contain reserved bits. These bits are labeled "Reserved". Software must deal correctly with fields that are reserved. On reads, software must use appropriate masks to extract the defined bits and not rely on reserved bits being any particular value. On writes, software must ensure that the values of reserved bit positions are preserved. That is, the values of reserved bit positions must first be read, merged with the new values for other bit positions and then written back. Note that software does not need to perform a read-merge-write operation for the Configuration Address (CONFIG_ADDRESS) register.
Reserved Registers	In addition to reserved bits within a register, the processor contains address locations in the configuration space that are marked either "Reserved" or "Intel Reserved". The processor responds to accesses to "Reserved" address locations by completing the host cycle. When a "Reserved" register location is read, a zero value is returned. ("Reserved" registers can be 8, 16, or 32 bits in size). Writes to "Reserved" registers have no effect on the processor. Registers that are marked as "Intel Reserved" must not be modified by system software. Writes to "Intel Reserved" registers may cause system failure. Reads to "Intel Reserved" registers may return a non-zero value.
Reset Value upon a Reset	Upon a reset, the processor sets all of its internal configuration registers to predetermined Reset Value states. Some register values at reset are determined by external strapping options. The Reset Value state represents the minimum functionality feature set required to successfully bring up the system. Hence, it does not represent the optimal system configuration. It is the responsibility of the system initialization software (usually BIOS) to properly determine the DRAM configurations, operating parameters, and optional system features that are applicable, and to program the processor registers accordingly.
"ST" appended to the end of a bit name	The bit is "sticky" or unchanged by a hard reset. These bits can only be cleared by a PWRGOOD reset.

2.2 Platform Configuration Structure

The processor contains 6 PCI devices within a single physical component. The configuration registers for these devices are mapped as devices residing on the PCI bus assigned for the processor socket. Bus number is derived by the maximum bus range setting and processor socket number.

- **Device 0**—Generic processor non-core. Device 0, Function 0 contains the generic non-core configuration registers for the processor and resides at DID (Device ID) of 2C70h. Device 0, Function 1 contains the System Address Decode registers and resides at DID of 2D81h.
- **Device 2**—Intel QuickPath Interconnect (Intel QPI). Device 2, Function 0 contains the Intel QuickPath Interconnect configuration registers for Intel QPI Link 0 and resides at DID of 2D90h. Device 2, Function 1 contains the physical layer registers for Intel QPI Link 0 and resides at DID of 2D91h. Device 2, Function 2 contains the mirror port registers for Intel QPI Link 0 and resides at DID of 2D92h. Device 2, Function 3 contains the mirror port registers for Intel QPI Link 1 and resides at DID of 2D93h. Device 2, Function 4 contains the Intel QuickPath configuration registers for Intel QuickPath Interconnect Link 1 and resides at DID of 2D94h. Device 2, Function 5 contains the physical layer registers for Intel QPI Link 1 and resides at DID of 2D95h. Functions 4 and 5 only apply to processors with two Intel QPI links.
- **Device 3**—Integrated Memory Controller. Device 3, Function 0 contains the general registers for the Integrated Memory Controller and resides at DID of 2D98h. Device 3, Function 1 contains the Target Address Decode registers for the Integrated Memory Controller and resides at DID of 2D99h. Device 3, Function 2 contains the RAS registers for the Integrated Memory Controller and resides at DID of 2D9Ah. Device 3, Function 4 contains the test registers for the Integrated Memory Controller and resides at DID of 2D9Ch. Function 2 only applies to processors supporting registered DIMMs.



- **Device 4**—Integrated Memory Controller Channel 0. Device 4, Function 0 contains the control registers for Integrated Memory Controller Channel 0 and resides at DID of 2DA0h. Device 4, Function 1 contains the address registers for Integrated Memory Controller Channel 0 and resides at DID of 2DA1h. Device 4, Function 2 contains the rank registers for Integrated Memory Controller Channel 0 and resides at DID of 2DA2h. Device 4, Function 3 contains the thermal control registers for Integrated Memory Controller Channel 0 and resides at DID of 2DA3h.
- **Device 5**—Integrated Memory Controller Channel 1. Device 5, Function 0 contains the control registers for Integrated Memory Controller Channel 1 and resides at DID of 2DA8h. Device 5, Function 1 contains the address registers for Integrated Memory Controller Channel 1 and resides at DID of 2DA9h. Device 5, Function 2 contains the rank registers for Integrated Memory Controller Channel 1 and resides at DID of 2DAAh. Device 5, Function 3 contains the thermal control registers for Integrated Memory Controller Channel 1 and resides at DID of 2DABh.
- **Device 6**—Integrated Memory Controller Channel 2. Device 6, Function 0 contains the control registers for Integrated Memory Controller Channel 2 and resides at DID of 2DB0h. Device 6, Function 1 contains the address registers for Integrated Memory Controller Channel 2 and resides at DID of 2DB1h. Device 6, Function 2 contains the rank registers for Integrated Memory Controller Channel 2 and resides at DID of 2DB2h. Device 6, Function 3 contains the thermal control registers for Integrated Memory Controller Channel 2 and resides at DID of 2DB3h.

2.3 Device Mapping

Each component in the processor is uniquely identified by a PCI bus address consisting of Bus Number, Device Number and Function Number. Device configuration is based on the PCI Type 0 configuration conventions. All processor registers appear on the PCI bus assigned for the processor socket. Bus number is derived by the maximum bus range setting and processor socket number.

Table 2-1. Functions Specifically Handled by the Processor

Component	Register Group	DID	Device	Function
Processor	Intel QuickPath Architecture Generic Non-core Registers	2C70h	0	0
	Intel QuickPath Architecture System Address Decoder	2D81h		1
	Intel QuickPath Interconnect (Intel QPI) Link 0	2D90h		0
	Intel QPI Physical 0	2D91h		1
	Mirror Port Link 0	2D92h		2
	Mirror Port Link 1	2D93h		3
	Intel QPI Link 1	2D94h		4 ¹
	Intel QPI Physical 1	2D95h		5 ¹
	Integrated Memory Controller Registers	2D98h	3	0
	Integrated Memory Controller Target Address Decoder	2D99h		1
	Integrated Memory Controller RAS Registers	2D9Ah		2 ²
	Integrated Memory Controller Test Registers	2D9Ch		4
	Integrated Memory Controller Channel 0 Control	2DA0h	4	0
	Integrated Memory Controller Channel 0 Address	2DA1h		1
	Integrated Memory Controller Channel 0 Rank	2DA2h		2
	Integrated Memory Controller Channel 0 Thermal Control	2DA3h		3
	Integrated Memory Controller Channel 1 Control	2DA8h	5	0
	Integrated Memory Controller Channel 1 Address	2DA9h		1
	Integrated Memory Controller Channel 1 Rank	2DAAh		2
	Integrated Memory Controller Channel 1 Thermal Control	2DABh		3
	Integrated Memory Controller Channel 2 Control	2DB0h	6	0
	Integrated Memory Controller Channel 2 Address	2DB1h		1
	Integrated Memory Controller Channel 2 Rank	2DB2h		2
	Integrated Memory Controller Channel 2 Thermal Control	2DB3h		3

Notes:

1. Applies only to processors with two Intel QPI links.
2. Applies only to processors supporting mirroring and scrubbing RAS features.

2.4 Detailed Configuration Space Maps

Table 2-2. Device 0, Function 0—Generic Non-core Registers

DID	VID	00h	DESIRED_CORES	80h
PCISTS	PCICMD	04h		84h
CCR	RID	08h	MEMLOCK_STATUS	88h
HDR		0Ch		8Ch
		10h	MC_CFG_CONTROL	90h
		14h		94h
		18h		98h
		1Ch		9Ch
		20h		A0h
		24h		A4h
		28h		A8h
SID	SVID	2Ch		ACh
		30h	POWER_CNTRL_ERR_STATUS	B0h
		34h		B4h
		38h		B8h
		3Ch		BCh
MAXREQUEST_LC		40h	CURRENT_UCLK_RATIO	C0h
MAXREQUEST_LS		44h		C4h
MAXREQUEST_LL		48h		C8h
		4Ch		CCh
MAX_RTIDS		50h	MIRROR_PORT_CTL	D0h
		54h		D4h
		58h		D8h
		5Ch		DCh
		60h		E0h
		64h		E4h
		68h		E8h
		6Ch		ECh
		70h		F0h
		74h		F4h
		78h		F8h
		7Ch		FCh



Table 2-3. Device 0, Function 1—System Address Decoder Registers

DID	VID	
PCISTS	PCICMD	
CCR	RID	
HDR		
SID	SVID	
SAD_PAM0123		
SAD_PAM456		
SAD_HEN		
SAD_SMRAM		
SAD_PCIEXBAR		
SAD_MCSEG_BASE		
SAD_MCSEG_MASK		
SAD_MESEG_BASE		
SAD_MESEG_MASK		
00h	SAD_DRAM_RULE_0	80h
04h	SAD_DRAM_RULE_1	84h
08h	SAD_DRAM_RULE_2	88h
0Ch	SAD_DRAM_RULE_3	8Ch
10h	SAD_DRAM_RULE_4	90h
14h	SAD_DRAM_RULE_5	94h
18h	SAD_DRAM_RULE_6	98h
1Ch	SAD_DRAM_RULE_7	9Ch
20h		A0h
24h		A4h
28h		A8h
2Ch		ACh
30h		B0h
34h		B4h
38h		B8h
3Ch		BCh
40h	SAD_INTERLEAVE_LIST_0	C0h
44h	SAD_INTERLEAVE_LIST_1	C4h
48h	SAD_INTERLEAVE_LIST_2	C8h
4Ch	SAD_INTERLEAVE_LIST_3	CCh
50h	SAD_INTERLEAVE_LIST_4	D0h
54h	SAD_INTERLEAVE_LIST_5	D4h
58h	SAD_INTERLEAVE_LIST_6	D8h
5Ch	SAD_INTERLEAVE_LIST_7	DCh
60h		E0h
64h		E4h
68h		E8h
6Ch		ECh
70h		F0h
74h		F4h
78h		F8h
7Ch		FCh

**Table 2-4. Device 2, Function 0—Intel® QuickPath Interconnect Link 0 Registers**

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
		00h	80h
		04h	84h
		08h	88h
		0Ch	8Ch
		10h	90h
		14h	94h
		18h	98h
		1Ch	9Ch
		20h	A0h
		24h	A4h
		28h	A8h
SID	SVID	2Ch	ACh
		30h	B0h
		34h	B4h
		38h	B8h
		3Ch	BCh
	QPI_QPILCP_L0	40h	COh
		44h	C4h
	QPI_QPILCL_L0	48h	C8h
		4Ch	CCh
	QPI_QPILS_L0	50h	D0h
		54h	D4h
	QPI_DEF_RMT_VN_CREDITS_L0	58h	D8h
		5Ch	DCh
		60h	E0h
		64h	E4h
		68h	E8h
		6Ch	ECh
		70h	F0h
		74h	F4h
		78h	F8h
		7Ch	FCh

Table 2-5. Device 2, Function 1—Intel® QuickPath Interconnect Physical 0 Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
QPI_0_PLL_STATUS			
QPI_0_PLL_RATIO			
QPI_0_PH_CPR			
QPI_0_PH_CTR			
00h	QPI_0_PH_PIS	80h	
04h		84h	
08h		88h	
0Ch		8Ch	
10h		90h	
14h	QPI_0_PH_PTV	94h	
18h		98h	
1Ch	QPI_0_PH_LDC	9Ch	
20h		A0h	
24h	QPI_0_PH_PRT	A4h	
28h		A8h	
2Ch		ACh	
30h		B0h	
34h		B4h	
38h		B8h	
3Ch		BCh	
40h		C0h	
44h		C4h	
48h		C8h	
4Ch		CCh	
50h	QPI_0_PH_PMRO	D0h	
54h		D4h	
58h		D8h	
5Ch		DCh	
60h	QPI_0_EP_SR	E0h	
64h		E4h	
68h		E8h	
6Ch		ECh	
70h		F0h	
74h	QPI_0_EP_MCTR	F4h	
78h		F8h	
7Ch		FCh	

**Table 2-6. Device 2, Function 2—Mirror Port Link 0 Registers**

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
00h			80h
04h			84h
08h			88h
0Ch			8Ch
10h			90h
14h			94h
18h			98h
1Ch			9Ch
20h			A0h
24h	MIP_PH_PRT_LO		A4h
28h			A8h
2Ch			ACh
30h			B0h
34h			B4h
38h			B8h
3Ch			BCh
40h			C0h
44h			C4h
48h			C8h
4Ch			CCh
50h			D0h
54h			D4h
58h			D8h
5Ch			DCh
60h			E0h
64h			E4h
68h			E8h
6Ch			ECh
70h			F0h
74h			F4h
78h			F8h
7Ch			FCh
MIP_PH_CTR_LO			

Table 2-7. Device 2, Function 3—Mirror Port Link 1 Registers

DID	VID		00h	80h
PCISTS	PCICMD		04h	84h
CCR	RID		08h	88h
HDR			0Ch	8Ch
			10h	90h
			14h	94h
			18h	98h
			1Ch	9Ch
			20h	A0h
		MIP_PH_PRT_L1	24h	A4h
			28h	A8h
SID	SVID		2Ch	ACh
			30h	B0h
			34h	B4h
			38h	B8h
			3Ch	BCh
			40h	C0h
			44h	C4h
			48h	C8h
			4Ch	CCh
			50h	D0h
			54h	D4h
			58h	D8h
			5Ch	DCh
			60h	E0h
			64h	E4h
			68h	E8h
			6Ch	EC
		MIP_PH_CTR_L1	70h	F0h
			74h	F4h
			78h	F8h
			7Ch	FC

**Table 2-8. Device 2, Function 4—Intel® QuickPath Interconnect Link 1 Registers¹**

DID	VID		
PCISTS	PCICMD		
CCR		RID	
BIST	HDR		
		00h	80h
		04h	84h
		08h	88h
		0Ch	8Ch
		10h	90h
		14h	94h
		18h	98h
		1Ch	9Ch
		20h	A0h
		24h	A4h
		28h	A8h
SID	SVID	2Ch	ACh
		30h	B0h
		34h	B4h
		38h	B8h
		3Ch	BCh
QPI_QPILCP_L1		40h	C0h
		44h	C4h
QPI_QPILCL_L1		48h	C8h
		4Ch	CCh
QPI_QPILS_L1		50h	D0h
		54h	D4h
QPI_DEF_RMT_VN_CREDITS_L1		58h	D8h
		5Ch	DCh
		60h	E0h
		64h	E4h
		68h	E8h
		6Ch	ECh
		70h	F0h
		74h	F4h
		78h	F8h
		7Ch	FCh

Note:

1. Applies only to processors with two Intel QPI links.

Table 2-9. Device 2, Function 5—Intel® QuickPath Interconnect Physical 1 Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
QPI_1_PLL_STATUS			
QPI_1_PLL_RATIO			
QPI_1_PH_CPR			
QPI_1_PH_CTR			
00h	QPI_1_PH_PIS	80h	
04h		84h	
08h		88h	
0Ch		8Ch	
10h		90h	
14h	QPI_1_PH_PTV	94h	
18h		98h	
1Ch	QPI_1_PH_LDC	9Ch	
20h		A0h	
24h	QPI_1_PH_PRT	A4h	
28h		A8h	
2Ch		ACh	
30h		B0h	
34h		B4h	
38h		B8h	
3Ch		BCh	
40h		C0h	
44h		C4h	
48h		C8h	
4Ch		CCh	
50h	QPI_1_PH_PMRO	D0h	
54h		D4h	
58h		D8h	
5Ch		DCh	
60h	QPI_1_EP_SR	E0h	
64h		E4h	
68h		E8h	
6Ch		ECh	
70h		F0h	
74h	QPI_1_EP_MCTR	F4h	
78h		F8h	
7Ch		FCh	

Table 2-10. Device 3, Function 0—Integrated Memory Controller Registers

DID	VID		
PCISTS	PCICMD		
CCR		RID	
HDR			
		00h	80h
		04h	84h
		08h	88h
		0Ch	8Ch
		10h	90h
		14h	94h
		18h	98h
		1Ch	9Ch
		20h	A0h
		24h	A4h
		28h	A8h
SID	SVID	2Ch	ACh
		30h	B0h
		34h	B4h
		38h	B8h
		3Ch	BCh
		40h	C0h
		44h	C4h
MC_CONTROL		48h	C8h
MC_STATUS		4Ch	CCh
MC_SMI_DIMM_ERROR_STATUS		50h	D0h
MC_SMI_CNTRL		54h	D4h
		58h	D8h
MC_RESET_CONTROL		5Ch	DCh
MC_CHANNEL_MAPPER		60h	E0h
MC_MAX_DOD		64h	E4h
		68h	E8h
		6Ch	ECh
MC_RD_CRDT_INIT		70h	F0h
MC_CRDT_WR_THLD		74h	F4h
MC_SCRUBADDR_LO		78h	F8h
MC_SCRUBADDR_HI		7Ch	FCh

Table 2-11. Device 3, Function 1—Target Address Decoder Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
		TAD_DRAM_RULE_0	80h
		TAD_DRAM_RULE_1	84h
		TAD_DRAM_RULE_2	88h
		TAD_DRAM_RULE_3	8Ch
		TAD_DRAM_RULE_4	90h
		TAD_DRAM_RULE_5	94h
		TAD_DRAM_RULE_6	98h
		TAD_DRAM_RULE_7	9Ch
			A0h
			A4h
			A8h
			ACh
			B0h
			B4h
			B8h
			BCh
		TAD_INTERLEAVE_LIST_0	C0h
		TAD_INTERLEAVE_LIST_1	C4h
		TAD_INTERLEAVE_LIST_2	C8h
		TAD_INTERLEAVE_LIST_3	CCh
		TAD_INTERLEAVE_LIST_4	D0h
		TAD_INTERLEAVE_LIST_5	D4h
		TAD_INTERLEAVE_LIST_6	D8h
		TAD_INTERLEAVE_LIST_7	DCh
			E0h
			E4h
			E8h
			EC _h
			F0h
			F4h
			F8h
			FC _h



Table 2-12. Device 3, Function 2—Integrated Memory Controller RAS Registers¹

DID	VID	
PCISTS	PCICMD	
CCR	RID	
	HDR	
SID	SVID	
MC_SSRCONTROL		
MC_SCRUB_CONTROL		
MC_RAS_ENABLES		
MC_RAS_STATUS		
MC_SSSTATUS		

Note:

1. Applies only to processors supporting registered DIMMs.

Table 2-13. Device 3, Function 4—Integrated Memory Controller Test Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
		00h	MC_TEST_PH_PIS
		04h	
		08h	
		0Ch	
		10h	
		14h	
		18h	
		1Ch	
		20h	
		24h	
		28h	MC_TEST_PAT_GCTR
		2Ch	
		30h	MC_TEST_PAT_BA
		34h	
		38h	
		3Ch	MC_TEST_PAT_IS
		40h	MC_TEST_PAT_DCD
		44h	
		48h	
		4Ch	
MC_DIMM_CLK_RATIO_STATUS		50h	
MC_DIMM_CLK_RATIO		54h	
		58h	
		5Ch	
MC_TEST_ERR_RCV1		60h	
MC_TEST_ERR_RCV0		64h	
		68h	
MC_TEST_PH_CTR		6Ch	
		70h	
		74h	
		78h	
		7Ch	



Table 2-14. Device 4, Function 0—Integrated Memory Controller Channel 0 Control Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
MC_CHANNEL_0_DIMM_RESET_CMD			
MC_CHANNEL_0_DIMM_INIT_CMD			
MC_CHANNEL_0_DIMM_INIT_PARAMS			
MC_CHANNEL_0_DIMM_INIT_STATUS			
MC_CHANNEL_0_DDR3CMD			
MC_CHANNEL_0_REFRESH_THROTTLE_SUPPORT			
MC_CHANNEL_0_MRS_VALUE_0_1			
MC_CHANNEL_0_MRS_VALUE_2			
MC_CHANNEL_0_CKE_TIMING_B			
MC_CHANNEL_0_RANK_PRESENT			
00h	MC_CHANNEL_0_RANK_TIMING_A	80h	
04h	MC_CHANNEL_0_RANK_TIMING_B	84h	
08h	MC_CHANNEL_0_BANK_TIMING	88h	
0Ch	MC_CHANNEL_0_REFRESH_TIMING	8Ch	
10h	MC_CHANNEL_0_CKE_TIMING	90h	
14h	MC_CHANNEL_0_ZO_TIMING	94h	
18h	MC_CHANNEL_0_RCOMP_PARAMS	98h	
1Ch	MC_CHANNEL_0_ODT_PARAMS1	9Ch	
20h	MC_CHANNEL_0_ODT_PARAMS2	A0h	
24h	MC_CHANNEL_0_ODT_MATRIX_RANK_0_3_RD	A4h	
28h	MC_CHANNEL_0_ODT_MATRIX_RANK_4_7_RD	A8h	
2Ch	MC_CHANNEL_0_ODT_MATRIX_RANK_0_3_WR	ACh	
30h	MC_CHANNEL_0_ODT_MATRIX_RANK_4_7_WR	B0h	
34h	MC_CHANNEL_0_WAQ_PARAMS	B4h	
38h	MC_CHANNEL_0_SCHEDULER_PARAMS	B8h	
3Ch	MC_CHANNEL_0_MAINTENANCE_OPS	BCh	
40h	MC_CHANNEL_0_TX_BG_SETTINGS	C0h	
44h		C4h	
48h	MC_CHANNEL_0_RX_BGF_SETTINGS	C8h	
4Ch	MC_CHANNEL_0_EW_BGF_SETTINGS	CCh	
50h	MC_CHANNEL_0_EW_BGF_OFFSET_SETTINGS	D0h	
54h	MC_CHANNEL_0_ROUND_TRIP_LATENCY	D4h	
58h	MC_CHANNEL_0_PAGETABLE_PARAMS1	D8h	
5Ch	MC_CHANNEL_0_PAGETABLE_PARAMS2	DCh	
60h	MC_TX_BG_CMD_DATA_RATIO_SETTING_CHO	E0h	
64h	MC_TX_BG_CMD_OFFSET_SETTINGS_CHO	E4h	
68h	MC_TX_BG_DATA_OFFSET_SETTINGS_CHO	E8h	
6Ch		ECh	
70h	MC_CHANNEL_0_ADDR_MATCH	F0h	
74h		F4h	
78h	MC_CHANNEL_0_ECC_ERROR_MASK	F8h	
7Ch	MC_CHANNEL_0_ECC_ERROR_INJECT	FCh	

**Table 2-15. Device 4, Function 1—Integrated Memory Controller Channel 0 Address Registers**

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
MC_DOD_CHO_0			
MC_DOD_CHO_1			
MC_DOD_CHO_2			
		MC_SAG_CHO_0	80h
		MC_SAG_CHO_1	84h
		MC_SAG_CHO_2	88h
		MC_SAG_CHO_3	8Ch
		MC_SAG_CHO_4	90h
		MC_SAG_CHO_5	94h
		MC_SAG_CHO_6	98h
		MC_SAG_CHO_7	9Ch
			A0h
			A4h
			A8h
			ACh
			B0h
			B4h
			B8h
			BCh
			C0h
			C4h
			C8h
			CCh
			D0h
			D4h
			D8h
			DCh
			E0h
			E4h
			E8h
			ECh
			F0h
			F4h
			F8h
			FCh

Table 2-16. Device 4, Function 2—Integrated Memory Controller Channel 0 Rank Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
SID	SVID		
MC_RIR_LIMIT_CHO_0			
MC_RIR_LIMIT_CHO_1			
MC_RIR_LIMIT_CHO_2			
MC_RIR_LIMIT_CHO_3			
MC_RIR_LIMIT_CHO_4			
MC_RIR_LIMIT_CHO_5			
MC_RIR_LIMIT_CHO_6			
MC_RIR_LIMIT_CHO_7			
00h	MC_RIR_WAY_CHO_0		80h
04h	MC_RIR_WAY_CHO_1		84h
08h	MC_RIR_WAY_CHO_2		88h
0Ch	MC_RIR_WAY_CHO_3		8Ch
10h	MC_RIR_WAY_CHO_4		90h
14h	MC_RIR_WAY_CHO_5		94h
18h	MC_RIR_WAY_CHO_6		98h
1Ch	MC_RIR_WAY_CHO_7		9Ch
20h	MC_RIR_WAY_CHO_8		A0h
24h	MC_RIR_WAY_CHO_9		A4h
28h	MC_RIR_WAY_CHO_10		A8h
2Ch	MC_RIR_WAY_CHO_11		ACh
30h	MC_RIR_WAY_CHO_12		B0h
34h	MC_RIR_WAY_CHO_13		B4h
38h	MC_RIR_WAY_CHO_14		B8h
3Ch	MC_RIR_WAY_CHO_15		BCh
40h	MC_RIR_WAY_CHO_16		C0h
44h	MC_RIR_WAY_CHO_17		C4h
48h	MC_RIR_WAY_CHO_18		C8h
4Ch	MC_RIR_WAY_CHO_19		CCh
50h	MC_RIR_WAY_CHO_20		D0h
54h	MC_RIR_WAY_CHO_21		D4h
58h	MC_RIR_WAY_CHO_22		D8h
5Ch	MC_RIR_WAY_CHO_23		DCh
60h	MC_RIR_WAY_CHO_24		E0h
64h	MC_RIR_WAY_CHO_25		E4h
68h	MC_RIR_WAY_CHO_26		E8h
6Ch	MC_RIR_WAY_CHO_27		ECh
70h	MC_RIR_WAY_CHO_28		F0h
74h	MC_RIR_WAY_CHO_29		F4h
78h	MC_RIR_WAY_CHO_30		F8h
7Ch	MC_RIR_WAY_CHO_31		FCh



Table 2-17. Device 4, Function 3—Integrated Memory Controller Channel 0 Thermal Control Registers

DID	VID	
PCISTS	PCICMD	
CCR		RID
	HDR	
SID	SVID	
MC_THERMAL_CONTROLO		
MC_THERMAL_STATUSO		
MC_THERMAL_DEFEATUREO		
MC_THERMAL_PARAMS_A0		
MC_THERMAL_PARAMS_B0		
MC_COOLING_COEFO		80h
MC_CLOSED_LOOPO		84h
MC_THROTTLE_OFFSETO		88h
		8Ch
		90h
		94h
MC_RANK_VIRTUAL_TEMPO		98h
MC_DDR_THERMO_COMMANDO		9Ch
MC_DDR_THERM1_COMMANDO		A0h
MC_DDR_THERMO_STATUSO		A4h
MC_DDR_THERM1_STATUSO		A8h
		ACh
		B0h
		B4h
		B8h
		BCh
		C0h
		C4h
		C8h
		CCh
		D0h
		D4h
		D8h
		DCh
		E0h
		E4h
		E8h
		EC
		F0h
		F4h
		F8h
		FC



Table 2-18. Device 5, Function 0—Integrated Memory Controller Channel 1 Control Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
MC_CHANNEL_1_DIMM_RESET_CMD			
MC_CHANNEL_1_DIMM_INIT_CMD			
MC_CHANNEL_1_DIMM_INIT_PARAMS			
MC_CHANNEL_1_DIMM_INIT_STATUS			
MC_CHANNEL_1_DDR3CMD			
MC_CHANNEL_1_REFRESH_THROTTLE_SUPPORT			
MC_CHANNEL_1_MRS_VALUE_0_1			
MC_CHANNEL_1_MRS_VALUE_2			
MC_CHANNEL_1_CKE_TIMING_B			
MC_CHANNEL_1_RANK_PRESENT			
00h	MC_CHANNEL_1_RANK_TIMING_A	80h	
04h	MC_CHANNEL_1_RANK_TIMING_B	84h	
08h	MC_CHANNEL_1_BANK_TIMING	88h	
0Ch	MC_CHANNEL_1_REFRESH_TIMING	8Ch	
10h	MC_CHANNEL_1_CKE_TIMING	90h	
14h	MC_CHANNEL_1_ZQ_TIMING	94h	
18h	MC_CHANNEL_1_RCOMP_PARAMS	98h	
1Ch	MC_CHANNEL_1_ODT_PARAMS1	9Ch	
20h	MC_CHANNEL_1_ODT_PARAMS2	A0h	
24h	MC_CHANNEL_1_ODT_MATRIX_RANK_0_3_RD	A4h	
28h	MC_CHANNEL_1_ODT_MATRIX_RANK_4_7_RD	A8h	
2Ch	MC_CHANNEL_1_ODT_MATRIX_RANK_0_3_WR	ACh	
30h	MC_CHANNEL_1_ODT_MATRIX_RANK_4_7_WR	B0h	
34h	MC_CHANNEL_1_WAQ_PARAMS	B4h	
38h	MC_CHANNEL_1_SCHEDULER_PARAMS	B8h	
3Ch	MC_CHANNEL_1_MAINTENANCE_OPS	BCh	
40h	MC_CHANNEL_1_TX_BG_SETTINGS	C0h	
44h		C4h	
48h	MC_CHANNEL_1_RX_BGF_SETTINGS	C8h	
4Ch	MC_CHANNEL_1_EW_BGF_SETTINGS	CCh	
50h	MC_CHANNEL_1_EW_BGF_OFFSET_SETTINGS	D0h	
54h	MC_CHANNEL_1_ROUND_TRIP_LATENCY	D4h	
58h	MC_CHANNEL_1_PAGETABLE_PARAMS1	D8h	
5Ch	MC_CHANNEL_1_PAGETABLE_PARAMS2	DCh	
60h	MC_TX_BG_CMD_DATA_RATIO_SETTING_CH1	E0h	
64h	MC_TX_BG_CMD_OFFSET_SETTINGS_CH1	E4h	
68h	MC_TX_BG_DATA_OFFSET_SETTINGS_CH1	E8h	
6Ch		ECh	
70h	MC_CHANNEL_1_ADDR_MATCH	F0h	
74h		F4h	
78h	MC_CHANNEL_1_ECC_ERROR_MASK	F8h	
7Ch	MC_CHANNEL_1_ECC_ERROR_INJECT	FCh	

**Table 2-19. Device 5, Function 1—Integrated Memory Controller Channel 1 Address Registers**

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
SID	SVID		
MC_DOD_CH1_0			
MC_DOD_CH1_1			
MC_DOD_CH1_2			
00h	MC_SAG_CH1_0	80h	
04h	MC_SAG_CH1_1	84h	
08h	MC_SAG_CH1_2	88h	
0Ch	MC_SAG_CH1_3	8Ch	
10h	MC_SAG_CH1_4	90h	
14h	MC_SAG_CH1_5	94h	
18h	MC_SAG_CH1_6	98h	
1Ch	MC_SAG_CH1_7	9Ch	
20h		A0h	
24h		A4h	
28h		A8h	
2Ch		ACh	
30h		B0h	
34h		B4h	
38h		B8h	
3Ch		BCh	
40h		C0h	
44h		C4h	
48h		C8h	
4Ch		CCh	
50h		D0h	
54h		D4h	
58h		D8h	
5Ch		DCh	
60h		E0h	
64h		E4h	
68h		E8h	
6Ch		ECh	
70h		F0h	
74h		F4h	
78h		F8h	
7Ch		FCh	

Table 2-20. Device 5, Function 2—Integrated Memory Controller Channel 1 Rank Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
SID	SVID		
MC_RIR_LIMIT_CH1_0			
MC_RIR_LIMIT_CH1_1			
MC_RIR_LIMIT_CH1_2			
MC_RIR_LIMIT_CH1_3			
MC_RIR_LIMIT_CH1_4			
MC_RIR_LIMIT_CH1_5			
MC_RIR_LIMIT_CH1_6			
MC_RIR_LIMIT_CH1_7			
00h	MC_RIR_WAY_CH1_0	80h	
04h	MC_RIR_WAY_CH1_1	84h	
08h	MC_RIR_WAY_CH1_2	88h	
0Ch	MC_RIR_WAY_CH1_3	8Ch	
10h	MC_RIR_WAY_CH1_4	90h	
14h	MC_RIR_WAY_CH1_5	94h	
18h	MC_RIR_WAY_CH1_6	98h	
1Ch	MC_RIR_WAY_CH1_7	9Ch	
20h	MC_RIR_WAY_CH1_8	A0h	
24h	MC_RIR_WAY_CH1_9	A4h	
28h	MC_RIR_WAY_CH1_10	A8h	
2Ch	MC_RIR_WAY_CH1_11	ACh	
30h	MC_RIR_WAY_CH1_12	B0h	
34h	MC_RIR_WAY_CH1_13	B4h	
38h	MC_RIR_WAY_CH1_14	B8h	
3Ch	MC_RIR_WAY_CH1_15	BCh	
40h	MC_RIR_WAY_CH1_16	C0h	
44h	MC_RIR_WAY_CH1_17	C4h	
48h	MC_RIR_WAY_CH1_18	C8h	
4Ch	MC_RIR_WAY_CH1_19	CCh	
50h	MC_RIR_WAY_CH1_20	D0h	
54h	MC_RIR_WAY_CH1_21	D4h	
58h	MC_RIR_WAY_CH1_22	D8h	
5Ch	MC_RIR_WAY_CH1_23	DCh	
60h	MC_RIR_WAY_CH1_24	E0h	
64h	MC_RIR_WAY_CH1_25	E4h	
68h	MC_RIR_WAY_CH1_26	E8h	
6Ch	MC_RIR_WAY_CH1_27	ECh	
70h	MC_RIR_WAY_CH1_28	F0h	
74h	MC_RIR_WAY_CH1_29	F4h	
78h	MC_RIR_WAY_CH1_30	F8h	
7Ch	MC_RIR_WAY_CH1_31	FCh	

**Table 2-21. Device 5, Function 3—Integrated Memory Controller Channel 1 Thermal Control Registers**

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
MC_THERMAL_CONTROL1			
MC_THERMAL_STATUS1			
MC_THERMAL_DEFEATURE1			
MC_THERMAL_PARAMS_A1			
MC_THERMAL_PARAMS_B1			
		MC_COOLING_COEF1	80h
		MC_CLOSED_LOOP1	84h
		MC_THROTTLE_OFFSET1	88h
			8Ch
			90h
			94h
		MC_RANK_VIRTUAL_TEMP1	98h
		MC_DDR_THERMO_COMMAND1	9Ch
		MC_DDR_THERM1_COMMAND1	A0h
		MC_DDR_THERMO_STATUS1	A4h
		MC_DDR_THERM1_STATUS1	A8h
			ACh
			B0h
			B4h
			B8h
			BCh
			C0h
			C4h
			C8h
			CCh
			D0h
			D4h
			D8h
			DCh
			E0h
			E4h
			E8h
			ECh
			F0h
			F4h
			F8h
			FCh



Table 2-22. Device 6, Function 0—Integrated Memory Controller Channel 2 Control Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
MC_CHANNEL_2_DIMM_RESET_CMD			
MC_CHANNEL_2_DIMM_INIT_CMD			
MC_CHANNEL_2_DIMM_INIT_PARAMS			
MC_CHANNEL_2_DIMM_INIT_STATUS			
MC_CHANNEL_2_DDR3CMD			
MC_CHANNEL_2_REFRESH_THROTTLE_SUPPORT			
MC_CHANNEL_2_MRS_VALUE_0_1			
MC_CHANNEL_2_MRS_VALUE_2			
MC_CHANNEL_2_CKE_TIMING_B			
MC_CHANNEL_2_RANK_PRESENT			
00h	MC_CHANNEL_2_RANK_TIMING_A	80h	
04h	MC_CHANNEL_2_RANK_TIMING_B	84h	
08h	MC_CHANNEL_2_BANK_TIMING	88h	
0Ch	MC_CHANNEL_2_REFRESH_TIMING	8Ch	
10h	MC_CHANNEL_2_CKE_TIMING	90h	
14h	MC_CHANNEL_2_ZO_TIMING	94h	
18h	MC_CHANNEL_2_RCOMP_PARAMS	98h	
1Ch	MC_CHANNEL_2_ODT_PARAMS1	9Ch	
20h	MC_CHANNEL_2_ODT_PARAMS2	A0h	
24h	MC_CHANNEL_2_ODT_MATRIX_RANK_0_3_RD	A4h	
28h	MC_CHANNEL_2_ODT_MATRIX_RANK_4_7_RD	A8h	
2Ch	MC_CHANNEL_2_ODT_MATRIX_RANK_0_3_WR	ACh	
30h	MC_CHANNEL_2_ODT_MATRIX_RANK_4_7_WR	B0h	
34h	MC_CHANNEL_2_WAQ_PARAMS	B4h	
38h	MC_CHANNEL_2_SCHEDULER_PARAMS	B8h	
3Ch	MC_CHANNEL_2_MAINTENANCE_OPS	BCh	
40h	MC_CHANNEL_2_TX_BG_SETTINGS	C0h	
44h		C4h	
48h	MC_CHANNEL_2_RX_BGF_SETTINGS	C8h	
4Ch	MC_CHANNEL_2_EW_BGF_SETTINGS	CCh	
50h	MC_CHANNEL_2_EW_BGF_OFFSET_SETTINGS	D0h	
54h	MC_CHANNEL_2_ROUND_TRIP_LATENCY	D4h	
58h	MC_CHANNEL_2_PAGETABLE_PARAMS1	D8h	
5Ch	MC_CHANNEL_2_PAGETABLE_PARAMS2	DCh	
60h	MC_TX_BG_CMD_DATA_RATIO_SETTING_CH2	E0h	
64h	MC_TX_BG_CMD_OFFSET_SETTINGS_CH2	E4h	
68h	MC_TX_BG_DATA_OFFSET_SETTINGS_CH2	E8h	
6Ch		ECh	
70h	MC_CHANNEL_2_ADDR_MATCH	F0h	
74h		F4h	
78h	MC_CHANNEL_2_ECC_ERROR_MASK	F8h	
7Ch	MC_CHANNEL_2_ECC_ERROR_INJECT	FCh	

**Table 2-23. Device 6, Function 1—Integrated Memory Controller Channel 2 Address Registers**

DID	VID		
PCISTS	PCICMD		
CCR	RID		
HDR			
SID	SVID		
MC_DOD_CH2_0			
MC_DOD_CH2_1			
MC_DOD_CH2_2			
		MC_SAG_CH2_0	80h
		MC_SAG_CH2_1	84h
		MC_SAG_CH2_2	88h
		MC_SAG_CH2_3	8Ch
		MC_SAG_CH2_4	90h
		MC_SAG_CH2_5	94h
		MC_SAG_CH2_6	98h
		MC_SAG_CH2_7	9Ch
			A0h
			A4h
			A8h
			ACh
			B0h
			B4h
			B8h
			BCh
			C0h
			C4h
			C8h
			CCh
			D0h
			D4h
			D8h
			DCh
			E0h
			E4h
			E8h
			ECh
			F0h
			F4h
			F8h
			FCh

Table 2-24. Device 6, Function 2—Integrated Memory Controller Channel 2 Rank Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
SID	SVID		
MC_RIR_LIMIT_CH2_0			
MC_RIR_LIMIT_CH2_1			
MC_RIR_LIMIT_CH2_2			
MC_RIR_LIMIT_CH2_3			
MC_RIR_LIMIT_CH2_4			
MC_RIR_LIMIT_CH2_5			
MC_RIR_LIMIT_CH2_6			
MC_RIR_LIMIT_CH2_7			
00h	MC_RIR_WAY_CH2_0		80h
04h	MC_RIR_WAY_CH2_1		84h
08h	MC_RIR_WAY_CH2_2		88h
0Ch	MC_RIR_WAY_CH2_3		8Ch
10h	MC_RIR_WAY_CH2_4		90h
14h	MC_RIR_WAY_CH2_5		94h
18h	MC_RIR_WAY_CH2_6		98h
1Ch	MC_RIR_WAY_CH2_7		9Ch
20h	MC_RIR_WAY_CH2_8		A0h
24h	MC_RIR_WAY_CH2_9		A4h
28h	MC_RIR_WAY_CH2_10		A8h
2Ch	MC_RIR_WAY_CH2_11		ACh
30h	MC_RIR_WAY_CH2_12		B0h
34h	MC_RIR_WAY_CH2_13		B4h
38h	MC_RIR_WAY_CH2_14		B8h
3Ch	MC_RIR_WAY_CH2_15		BCh
40h	MC_RIR_WAY_CH2_16		C0h
44h	MC_RIR_WAY_CH2_17		C4h
48h	MC_RIR_WAY_CH2_18		C8h
4Ch	MC_RIR_WAY_CH2_19		CCh
50h	MC_RIR_WAY_CH2_20		D0h
54h	MC_RIR_WAY_CH2_21		D4h
58h	MC_RIR_WAY_CH2_22		D8h
5Ch	MC_RIR_WAY_CH2_23		DCh
60h	MC_RIR_WAY_CH2_24		E0h
64h	MC_RIR_WAY_CH2_25		E4h
68h	MC_RIR_WAY_CH2_26		E8h
6Ch	MC_RIR_WAY_CH2_27		ECh
70h	MC_RIR_WAY_CH2_28		F0h
74h	MC_RIR_WAY_CH2_29		F4h
78h	MC_RIR_WAY_CH2_30		F8h
7Ch	MC_RIR_WAY_CH2_31		FCh

Table 2-25. Device 6, Function 3—Integrated Memory Controller Channel 2 Thermal Control Registers

DID	VID		
PCISTS	PCICMD		
CCR	RID		
	HDR		
00h	MC_COOLING_COEF2	80h	
04h	MC_CLOSED_LOOP2	84h	
08h	MC_THROTTLE_OFFSET2	88h	
0Ch		8Ch	
10h		90h	
14h		94h	
18h	MC_RANK_VIRTUAL_TEMP2	98h	
1Ch	MC_DDR_THERMO_COMMAND2	9Ch	
20h	MC_DDR_THERM1_COMMAND2	A0h	
24h	MC_DDR_THERMO_STATUS2	A4h	
28h	MC_DDR_THERM1_STATUS2	A8h	
2Ch		ACh	
30h		B0h	
34h		B4h	
38h		B8h	
3Ch		BCh	
40h		C0h	
44h		C4h	
48h	MC_THERMAL_CONTROL2	C8h	
4Ch	MC_THERMAL_STATUS2	CCh	
50h	MC_THERMAL_DEFEATURE2	D0h	
54h		D4h	
58h		D8h	
5Ch		DCh	
60h	MC_THERMAL_PARAMS_A2	E0h	
64h	MC_THERMAL_PARAMS_B2	E4h	
68h		E8h	
6Ch		ECh	
70h		F0h	
74h		F4h	
78h		F8h	
7Ch		FCh	



2.5 PCI Standard Registers

These registers appear in every function for every device.

2.5.1 DID—Device Identification Register

This 16-bit register combined with the Vendor Identification register uniquely identifies the Function within the processor. Writes to this register have no effect. See [Table 2-1](#) for the DID of each processor function.

Device:	0		
Function:	0–1		
Offset:	02h		
Device:	2		
Function:	0–5		
Offset:	02h		
Device:	3		
Function:	0–2, 4		
Offset:	02h		
Device:	4–6		
Function:	0–3		
Offset:	02h		
Bit	Type	Reset Value	Description
15:0	RO	*See Table 2-1	Device Identification Number This field identifies each function of the processor.

2.5.2 RID—Revision Identification Register

This register contains the revision number of the processor. The Revision ID (RID) is a traditional 8-bit Read Only (RO) register located at offset 08h in the standard PCI header of every PCI/PCI Express compatible device and function.

Device:	0		
Function:	0–1		
Offset:	08h		
Device:	2		
Function:	0–5		
Offset:	08h		
Device:	3		
Function:	0–2, 4		
Offset:	08h		
Device:	4–6		
Function:	0–3		
Offset:	08h		
Bit	Type	Reset Value	Description
7:0	RO	0h	Revision Identification Number Refer to the <i>Intel® Core™ i7-900 Desktop Processor Extreme Edition Series and Intel® Core™ i7-900 Desktop Processor Series on 32-nm Process Specification Update</i> for the value of the Revision ID Register.

2.6 Generic Non-core Registers

2.6.1 DESIRED_CORES

Number of cores, threads BIOS wants to exist on the next reset. A processor reset must be used for this register to take affect. Note that programing this register to a value higher than the product has cores, should not be done. Which cores are removed is not defined and is implementation dependent. This does not result in all of the power savings of a reduced number of core product, but does save more power than even the deepest sleep state.

Device: 0 Function: 0 Offset: 80h Access as a Dword			
Bit	Type	Reset Value	Description
31:17	RO		Reserved
16	RW1S	0	LOCK Once this bit is written to 1, changes to this register cannot be made.
15:9	RO		Reserved
8	RWL	0	MT_DISABLE When set to 1, this bit disables multi-threading (2 logical threads per core) in all cores.
7:3	RO		Reserved
2:0	RWL	000	CORE_COUNT 000 = maximum number (reset value) 001 = 1 core 010 = 2 cores 011 = 3 cores 100 = 4 cores 101 = 5 cores

2.6.2 MIRROR_PORT_CTL—Mirror Port Control Register

Device: 0 Function: 0 Offset: D0h Access as a Dword			
Bit	Type	Reset Value	Description
31:7	-	-	Reserved
6	RW	0	DSBL_ENH_MPRX_SYNC 1 = Disables the enhancing synchronization scheme for the MiP_Rx. 0 = Enable
5	RW	0	MIP_GO_10 1 = Mip_Tx and Mip_Rx go to L0 directly from Config_FlitLock.
4	RW	0	MIP_RX_CRC_SQUASH 1 = CRC errors are replaced with a CRC special packet on MiP Rx.
3	RW	0	MIP_RX_PORT_SEL . Port select for MiP Rx. 0 = QPI Port 0. 1 = QPI Port 1.
2	RW	0	MIP_TX_PORT_SEL . Port select for MiP Tx. 0 = QPI Port 0. 1 = QPI Port 1.
1	RW	1	MIP_RX_ENABLE 1 = Enables the Rx portion of the mirror port. 0 = Disable
0	RW	1	MIP_TX_ENABLE 1 = Enables the Tx portion of the mirror port. 0 = Disable

2.7 SAD—System Address Decoder Registers

2.7.1 SAD_MCSEG_BASE

This is the Global register for MCSEG address space. These are designed to look just like the cores SMRR type registers.

Device: 0 Function: 1 Offset: 60h Access as a Qword			
Bit	Type	Reset Value	Description
63:40	RO		Reserved
39:19	RW	0	BASE_ADDRESS This field specifies the base address of the MCSEG. The address must be aligned on 512 KB or greater boundary.
18:0	RO		Reserved

2.7.2 SAD_MCSEG_MASK

This is the Global register for the MCSEG address space. These are designed to look just like the cores SMRR type registers.

Device: 0 Function: 1 Offset: 68h Access as a Qword			
Bit	Type	Reset Value	Description
63:40	RO		Reserved
39:19	RW	0	MASK This field specifies the mask value for the MCSEG. For initial implementations, this must be a 2 MB mask value = 0000_0OFF_FFE0_0000h = (1FFFFCh << 19).
18:12	RO		Reserved
11	RW	0	ENABLE 1 = All chipset accesses to this range are aborted and generate a Machine Check. 0 = Disable
10	RW	0	LOCK 1 = Prevents modifications to the next SAD_MCSEG_BASE and SAD_MCSEG_MASK registers until the next reset.
9:0	RO		Reserved



2.7.3 SAD_MESEG_BASE

This register is for ME stolen range address space. They are designed to look like the core SMRR type registers.

Device: 0 Function: 1 Offset: 70h Access as a Qword			
Bit	Type	Reset Value	Description
63:40	RO		Reserved
39:19	RW	0	BASE_ADDRESS This field specifies the base address of the MESEG. The address must be aligned on 512 KB or greater boundary.
18:0	RO		Reserved

2.7.4 SAD_MESEG_MASK

This register is for ME stolen range address space. It is designed to look just like the core SMRR type registers.

Device: 0 Function: 1 Offset: 78h Access as a Qword			
Bit	Type	Reset Value	Description
63:40	RO		Reserved
39:19	RW	0	MASK. Mask of MESEG. The space must be power of 2 aligned. Bits must match the BASE in order to be inside the ME range.
11	RW	0	ENABLE This bit indicates if ME stolen range is enabled. 1 = Enable. All core accesses to this range are aborted. 0 = Disable
10	RW	0	LOCK This bit indicates if ME stolen range base/mask is locked. 1 = Lock. Prevents modifications to the next SAD_MCSEG_BASE and SAD_MCSEG_MASK registers until the next reset. 0 = Not Lock
9:0	RO		Reserved



2.8 Intel QPI Link Registers

2.8.1 QPI_DEF_RMT_VN_CREDITS_L0 QPI_DEF_RMT_VN_CREDITS_L1

This is the control register that contains the default values of available remote credits to be transmitted to the remote agent for remote Tx use.

Device: 2 Function: 0, 4 Offset: 58h Access as a Dword			
Bit	Type	Reset Value	Description
31:19	RO		Reserved
18:12	RW	100	VNA. VNA Credits.
11:10	RW	1	NCS. NCS Channel VNO Credits.
9:8	RW	1	NCB. NCB Channel VNO Credits.
7:6	RW	1	DRS. DRS Channel VNO Credits.
5:4	RW	1	NDR. NDRChannel VNO Credits.
3:2	RW	1	SNP. SNP Channel VNO Credits.
1:0	RW	1	HOM. HOMChannel VNO Credits.

2.8.2 QPI_RMT_QPILP1_STAT_L0 QPI_RMT_QPILP1_STAT_L1

This is the remote Intel QPI Parameter 1 Value register.

Device: 2 Function: 0, 4 Offset: C4h Access as a Dword			
Bit	Type	Reset Value	Description
31:12	RO	—	Reserved
11	RO	—	BP_Request This bit indicates whether the remote agent is requesting back pressure during L1 state.
10	RO	—	BP_Support This bit indicates the remote agent's ability to support back pressure during the L1 state.
9	RO	—	L1_SUPPORT This bit indicates the remote agent's ability to support the L1 state.
8	RO	—	LOP_SUPPORT This bit indicates the remote agent's ability to support the LOP state.
7	RO	—	LOS_SUPPORT This bit indicates the remote agent's ability to support the LOS state.
6	RO	—	RX_CII_SUPPORT This bit indicates the remote agent's ability to receive CII data.
5	RO	—	PREFERRED_TX_SDII_MODE This bit indicates the ability of the remote agent transmitter to send scheduled data interleave data.
4	RO	—	RCV_SDII_SUPPORT This bit indicates that the remote agent can receive scheduled data interleave data.
3:2	RO	—	PREFERRED_TX_CRC_MODE This field indicates preferred send mode for the remote transmitter. 00 = No CRC 01 = 8b CRC 10 = 16b rolling CRC 11 = Reserved
1:0	RO	—	RCV_CRC_MODE_SUPPORTED This field indicates the CRC modes that the remote agent supports. 00 = Reserved 01 = 8b CRC 10 = 16b and 8b CRC 11 = Reserved



2.8.3 MIP_PH_CTR_LO MIP_PH_CTR_L1

This is the Mirror Port Physical Layer Control Register.

Device: 2 Function: 2,3 Offset: 6Ch Access as a Dword			
Bit	Type	Reset Value	Description
31	RW	0	RETRAIN_NOW This bit generates a retraining event with the provided retraining parameters when enabled only during at-speed operation.
30:28	RO		Reserved
27	RW	0	LA_LOAD_DISABLE 1 = Disables the loading of the effective values of the Intel QuickPath CSRs when set. 0 = Enable
26:24	RO		Reserved
23	RW	0	ENABLE_PRBS This bit enables LFSR pattern during bit lock/training. 1 = Enable 0 = Disable
22	RW	0	ENABLE_SCRAMBLE This bit enables data scrambling through LFSR. 1 = Enable 0 = Disable
21:15	RO		Reserved
14	RW	1	DETERMINISM_MODE This bit sets the determinism mode of operation.
13	RW	1	DISABLE_AUTO_COMP This bit disables automatic entry into compliance.
12	RW	0	INIT_FREEZE 1 = Freezes the FSM when initialization aborts.
11	RO		Reserved
10:8	RW	0	INIT_MODE This field indicates initialization mode that determines altered initialization modes.
7	RW	0	LINK_SPEED This bit identifies slow speed or at-speed operation for the Intel QPI port.
6	RO		Reserved
5	RW	1	PHYINITBEGIN This bit instructs the port to start initialization.
4	RW	0	SINGLE_STEP This bit enables single step mode. 1 = Enable 0 = Disable
3	RW	0	LAT_FIX_CTL If set, this bit instructs the remote agent to fix the latency.
2	RW	0	BYPASS_CALIBRATION This bit indicates the physical layer to bypass calibration. 1 = Bypass 0 = No Bypass
1	RW	0	RESET_MODIFIER When set, this bit modifies soft reset to default reset.
0	RW1S	0	PHY_RESET . Physical Layer Reset. Note that while this register is locked after going to FAST speed LO, this bit is not locked.



2.8.4 MIP_PH_PRT_LO MIP_PH_PRT_L1

This is the Mirror Port Periodic Retraining Timing register.

Device: 2 Function: 2, 3 Offset: A4h Access as a Dword			
Bit	Type	Reset Value	Description
31:20	RO		Reserved
21:16	RW	29	RETRAIN_PKT_CNT. Retraining Packet Count.
15:14	RO		Reserved
13:10	RW	11	EXP_RETRAIN_INTERVAL. Exponential Count for Retraining Interval.
9:8	RO		Reserved
7:0	RW	3	RETRAIN_INTERVAL. Periodic Retraining Interval. A value of 0 indicates retraining is disabled.

2.9 Integrated Memory Controller Control Registers

The registers in this section apply only to processors supporting registered DIMMs

2.9.1 MC_SMI_DIMM_ERROR_STATUS

SMI DIMM error threshold overflow status register. These bits are set when the per-DIMM error counter exceeds the specified threshold. The bit is reset by BIOS.

Device: 3 Function: 0 Offset: 50h Access as a Dword			
Bit	Type	Reset Value	Description
31:14	RO		Reserved
13:12	RWOC	0	REDUNDANCY_LOSS FAILING_DIMM The ID for the failing DIMM when redundancy is lost.
11:0	RWOC	0	DIMM_ERROR_OVERFLOW_STATUS This 12-bit field is the per DIMM error overflow status bits. The organization is as follows: If there are three or more DIMMS on the channel: Bit 0 = DIMM 0 Channel 0 Bit 1 = DIMM 1 Channel 0 Bit 2 = DIMM 2 Channel 0 Bit 3 = DIMM 3 Channel 0 Bit 4 = DIMM 0 Channel 1 Bit 5 = DIMM 1 Channel 1 Bit 6 = DIMM 2 Channel 1 Bit 7 = DIMM 3 Channel 1 Bit 8 = DIMM 0 Channel 2 Bit 9 = DIMM 1 Channel 2 Bit 10 = DIMM 2 Channel 2 Bit 11 = DIMM 3 Channel 2 If there are one or two DIMMS on the channel: Bit 0 = DIMM 0, Ranks 0 and 1, Channel 0 Bit 1 = DIMM 0, Ranks 2 and 3, Channel 0 Bit 2 = DIMM 1, Ranks 0 and 1, Channel 0 Bit 3 = DIMM 1, Ranks 2 and 3, Channel 0 Bit 4 = DIMM 0, Ranks 0 and 1, Channel 1 Bit 5 = DIMM 0, Ranks 2 and 3, Channel 1 Bit 6 = DIMM 1, Ranks 0 and 1, Channel 1 Bit 7 = DIMM 1, Ranks 2 and 3, Channel 1 Bit 8 = DIMM 0, Ranks 0 and 1, Channel 2 Bit 9 = DIMM 0, Ranks 2 and 3, Channel 2 Bit 10 = DIMM 1, Ranks 0 and 1, Channel 2 Bit 11 = DIMM 1, Ranks 2 and 3, Channel 2



2.9.2 MC_SMI__CNTRL

This is the System Management Interrupt Control register.

Device: 3 Function: 0 Offset: 54h Access as a Dword			
Bit	Type	Reset Value	Description
31:17	RO		Reserved
16	RW	0	INTERRUPT_SELECT_NMI. NMI enable. 1 = Enable NMI signaling 0 = Disable NMI signaling. If both NMI and SMI enable bits are set, then only SMI is sent.
15	RW	0	INTERRUPT_SELECT_SMI. SMI enable. 1 = Enable SMI signaling 0 = Disable SMI signaling. If both NMI and SMI enable bits are set, then only SMI is sent. This bit functions the same way in Mirror and Independent Modes. The possible SMI events enabled by this bit are: Any one of the error counters MC_COR_ECC_CNT_X that meets the value of SMI_ERROR_THRESHOLD field of this register. MC_RAS_STATUS.REDUNDANCY_LOSS bit is set to 1.
14:0	RW	00..00	SMI_ERROR_THRESHOLD This field defines the error threshold to compare against the per-DIMM error counters MC_COR_ECC_CNT_X, which are also 15 bits.



2.9.3 MC_MAX_DOD

This register defines the maximum number of DIMMS, RANKS, BANKS, ROWS, COLS among all DIMMS populating the three channels. The Memory Init logic uses this register to cycle through all the memory addresses, writing all 0s to initialize all locations. This register is also used for scrubbing and must always be programmed if any DODs are programmed.

Device: 3 Function: 0 Offset: 64h Access as a Dword			
Bit	Type	Reset Value	Description
31:11	RV		Reserved
10:9	RW	00	MAXNUMCOL. Maximum Number of Columns. 00 = 2^{10} columns 01 = 2^{11} columns 10 = 2^{12} columns 11 = Reserved
8:6	RW	000	MAXNUMROW. Maximum Number of Rows. 000 = 2^{12} Rows 001 = 2^{13} Rows 010 = 2^{14} Rows 011 = 2^{15} Rows 100 = 2^{16} Rows Others = Reserved
5:4	RW	00	MAXNUMBANK. Max Number of Banks. 00 = Four-banked 01 = Eight-banked 10 = Sixteen-banked 11 = Reserved
3:2	RW	00	MAXNUMRANK. Maximum Number of Ranks. 00 = Single Ranked 01 = Double Ranked 10 = Quad Ranked 11 = Reserved
1:0	RW	00	MAXNUMDIMMS. Maximum Number of DIMMs. 00 = 1 DIMM 01 = 2 DIMMs 10 = 3 DIMMs 11 = Reserved



2.9.4 MC_RD_CRDT_INIT

These registers contain the initial read credits available for issuing memory reads. TAD read credit counters are loaded with the corresponding values at reset and anytime this register is written. BIOS must initialize this register with appropriate values depending on the level of Isoch support in the platform. It is invalid to write this register while TAD is active (has memory requests outstanding), as the write will break TAD's outstanding credit count values.

Register programming rules:

- Total read credits (CRDT_RD + CRDT_RD_HIGH + CRDT_RD_CRIT) must not exceed 31.
- CRDT_RD_HIGH value must correspond to the number of high RTIDs reserved at the IOH.
- CRDT_RD_CRIT value must correspond to the number of critical RTIDs reserved at the IOH.
- CRDT_RD_HIGH + CRDT_RD must be less than or equal to 13 if High or Critical credits are nonzero.
- CRDT_RD_HIGH + CRDT_RD_CRIT must be less than or equal to 8.
- CRDT_RD_CRIT must be less than or equal to 6. Set CRDT_RD to $(16 - CRDT_RD_CRIT - CRDT_RD_HIGH)$.
- If (Mirroring enabled) then Max for CRDT_RD is 14, otherwise it is 15.
- If (Isoch not enabled) then CRDT_RD_HIGH and CRDT_RD_CRIT are set to 0.

Device: 3 Function: 0 Offset: 70h Access as a Dword			
Bit	Type	Reset Value	Description
31:21	RO		Reserved
20:16	RW	3h	CRDT_RD_CRIT. Critical Read Credits.
15:0	RO		Reserved
12:8	RW	1	CRDT_RD_HIGH. High Read Credits.
7:5	RO		Reserved
4:0	RW	13h	CRDT_RD. Normal Read Credits.



2.9.5 MC_SCRUBADDR_HI

This register pair contains part of the address of the last patrol scrub request issued. When running memtest, the failing address is logged in this register on memtest errors. Software can write the next address into this register. Scrubbing must be disabled to reliably read and write this register.

Access as a Dword			
Bit	Type	Reset Value	Description
31:13	RO		Reserved
12	RO	0	MEMBIST_INPROGRESS When this bit is set by hardware, MemTest/MemInit is in progress.
11	RO	0	MEMBIST_CMPLT When this bit is set by hardware, MemTest/MemInit is complete.
10	WO	0	RESET_MEMBIST_STATUS When this bit is written to a 1, the status field MEMBIST_CMPLT is cleared.
9:8	RW	00	CHNL This bit can be written to specify the next scrub address with STARTSCRUB in the MC_SCRUB_CONTROL register. Contains the channel address of the last patrol scrub issued.
7:6	RW	00	DIMM This field contains the DIMM of the last scrub issued. The field can be written to specify the next scrub address with STARTSCRUB in the MC_SCRUB_CONTROL register.
5:4	RW	00	RANK. This field contains the rank of the last scrub issued. The field can be written to specify the next scrub address with STARTSCRUB in the MC_SCRUB_CONTROL register.
3:0	RW	0000	BANK. This field contains the bank of the last scrub issued. The field can be written to specify the next scrub address with STARTSCRUB in the MC_SCRUB_CONTROL register.

2.10 Integrated Memory Controller RAS Registers

2.10.1 MC_SSRCONTROL

This register is for scrubbing control. The register allows the enabling of patrol scrubbing and demand scrubbing.

Device: 3 Function: 2 Offset: 48h Access as a Dword			
Bit	Type	Reset Value	Description
31:15	RO		Reserved
14:7	RW	00h	SCRATCHPAD. This field is available as a scratchpad for Scrubbing operations.
6	RW	0	DEMAND_SCRUB_EN. Enable Demand Scrubs.
5:2	RO		Reserved
1:0	RW	00	SSR_MODE. Spare control enable. 00 = Idle 01 = Scrub 10 = Reserved

2.10.2 MC_SCRUB_CONTROL

This register contains the Scrub control parameters and status.

Device: 3 Function: 2 Offset: 4Ch Access as a Dword			
Bit	Type	Reset Value	Description
31:30	RO		Reserved
29:27	RW	000	SKIP_SCRUB This bit disables patrol scrubs to the channel corresponding to the bit that is set. Bit 27 disables patrol scrubs to channel 0, bit 28 disables patrol scrubs to channel 1, and bit 29 disables patrol scrubs to channel 2. This bit can only be set or reset on a system with patrol scrub enabled, and only after transitioning the SSR_CONTROL.SSR_MODE to idle and polling until SSRSTATUS.CMPLT is 1. When mirroring is enabled, this field must not be set.
26	RW	0	SCRUBISSUED. When set to 1, it scrubs the address registers containing the last scrub address issued.
25	-	-	Reserved
24	RW	0	STARTSCRUB When set to 1, the Patrol scrub engine will start from the address in the scrub address registers. Once the scrub is issued, this bit is reset.
23:0	RW	00000h	SCRUBINTERVAL This field defines the interval in DCLKS between patrol scrub requests. The calculation for this register to get a scrub to every line in 24 hours is: ((36400)/(memory capacity/64))/cycle time of DCLK For 512 MB at DDR3-800: (36400/((2^29)/64))/1.25 x 10^-9 = 3471374 = 34F80Eh



2.10.3 MC_SSRSTATUS

This register provides the status of the operation specified in MC_SSRCONTROL.SSR_Mode.

Device: 3 Function: 2 Offset: 60h Access as a Dword			
Bit	Type	Reset Value	Description
31:2	RO		Reserved
1	RO	0	INPROGRESS. Patrol Scrub operation in progress. This bit is set by hardware once scrubbing operation has started. It is cleared once the operation is complete or fails.
0	RO	0	CMLT. Patrol Scrub operation complete. This bit is set by hardware once the operation is complete. The bit is cleared by hardware when a new operation is enabled.

2.11 Integrated Memory Controller Channel Control Registers

2.11.1 MC_CHANNEL_0_REFRESH_THROTTLE_SUPPORT MC_CHANNEL_1_REFRESH_THROTTLE_SUPPORT MC_CHANNEL_2_REFRESH_THROTTLE_SUPPORT

This register supports Self Refresh and Thermal Throttle functions.

Device: 4, 5, 6 Function: 0 Offset: 68h Access as a Dword			
Bit	Type	Reset Value	Description
31:6	RO		Reserved
5	RW	0	Reserved
4	RW	0	Reserved
3:2	RW	00	INC_ENTERPW RDWN RATE Powerdown rate will be increased during thermal throttling based on the following configurations. 00 = tRANKIDLE (reset value) 01 = 16 10 = 24 11 = 32
1	RW	0	DIS_OP_REFRESH When set to 1, the refresh engine will not issue opportunistic refresh.
0	RW	0	ASR_PRESENT When set to 1, this bit indicates DRAMs on this channel can support Automatic Self Refresh. If the DRAM is not supporting ASR (Auto Self Refresh), then Self Refresh entry will be delayed until the temperature is below the 2x refresh temperature.

2.11.2 MC_CHANNEL_0_RANK_TIMING_A MC_CHANNEL_1_RANK_TIMING_A MC_CHANNEL_2_RANK_TIMING_A

This register contains parameters that specify the rank timing used. All parameters are in DCLK.

Device: 4, 5, 6 Function: 0 Offset: 80h Access as a Dword			
Bit	Type	Reset Value	Description
31:29	RO		Reserved
28:26	RW	000b	tddWrTRd This field provides the minimum delay between a write followed by a read to different DIMMs. 000 = 1 001 = 2 010 = 3 011 = 4 100 = 5 101 = 6 110 = 7 111 = 8
25:23	RW	000b	tdrWrTRd This field provides the minimum delay between a write followed by a read to different ranks on the same DIMM. 000 = 1 001 = 2 010 = 3 011 = 4 100 = 5 101 = 6 110 = 7 111 = 8
22:19	RW	0000b	tsrWrTRd. This field provides the minimum delay between a write followed by a read to the same rank. 0000 = 10 0001 = 11 0010 = 12 0011 = 13 0100 = 14 0101 = 15 0110 = 16 0111 = 17 1000 = 18 1001 = 19 1010 = 20 1011 = 21 1100 = 22 1101 = 23 1110 = 24 1111 = 25



Device: 4, 5, 6 Function: 0 Offset: 80h Access as a Dword			
18:15	RW	0000b	tddRdTWr This field provides the minimum delay between Read followed by a Write to different DIMMs. 0000 = 2 0001 = 3 0010 = 4 0011 = 5 0100 = 6 0101 = 7 0110 = 8 0111 = 9 1000 = 10 1001 = 11 1010 = 12 1011 = 13 1100 = 14 1101 = Reserved 1110 = Reserved 1111 = Reserved
14:11	RW	0000b	tdrRdTWr This field provides the minimum delay between Read followed by a write to different ranks on the same DIMM. 0000 = 2 0001 = 3 0010 = 4 0011 = 5 0100 = 6 0101 = 7 0110 = 8 0111 = 9 1000 = 10 1001 = 11 1010 = 12 1011 = 13 1100 = 14 1101 = Reserved 1110 = Reserved 1111 = Reserved
10:7	RW	0000b	tsrRdTWr This field provides the minimum delay between Read followed by a write to the same rank. 0000 = Reserved 0001 = Reserved 0010 = Reserved 0011 = 5 0100 = 6 0101 = 7 0110 = 8 0111 = 9 1000 = 10 1001 = 11 1010 = 12 1011 = 13 1100 = 14 1101 = Reserved 1110 = Reserved 1111 = Reserved



Device: 4, 5, 6 Function: 0 Offset: 80h Access as a Dword			
6:4	RW	000b	<p>tddRdTRd.</p> <p>This field provides the minimum delay between reads to different DIMMs.</p> <p>000 = 2 001 = 3 010 = 4 011 = 5 100 = 6 101 = 7 110 = 8 111 = 9</p>
3:1	RW	000b	<p>tdrRdTRd.</p> <p>This field provides the minimum delay between reads to different ranks on the same DIMM.</p> <p>000 = 2 001 = 3 010 = 4 011 = 5 100 = 6 101 = 7 110 = 8 111 = 9</p>
0	RW	0	<p>tsrRdTRd.</p> <p>This bit provides the minimum delay between reads to the same rank.</p> <p>0 = 4 1 = 6</p>

2.11.3 MC_CHANNEL_0_REFRESH_TIMING MC_CHANNEL_1_REFRESH_TIMING MC_CHANNEL_2_REFRESH_TIMING

This register contains parameters that specify the refresh timings. Units are in DCLK.

Device: 4, 5, 6 Function: 0 Offset: 8Ch Access as a Dword			
Bit	Type	Reset Value	Description
31:30	RO		Reserved
29:19	RW	00..00b	tTHROT_OPPREF This field provides the minimum time between two opportunistic refreshes. The field should be set to tRFC in DCLKs. Zero is an invalid encoding. A value of 1 should be programmed to disable the throttling of opportunistic refreshes. By setting this field to tRFC, current to a single DIMM can be limited to that required to support this scenario without significant performance impact: <ul style="list-style-type: none"> • 8 panic refreshes in tREFI to one rank • 1 opportunistic refresh every tRFC to another rank • Full bandwidth delivered by the third and fourth ranks Platforms that can supply peak currents to the DIMMs should disable opportunistic refresh throttling for maximum performance.
18:9	RW	00..00b	tREFI_8 This field provides the average periodic refresh interval divided by 8.
8:0	RW	00..00b	tRFC This field provides the delay between the refresh command and an activate or refresh command.

2.11.4 MC_CHANNEL_0_CKE_TIMING MC_CHANNEL_1_CKE_TIMING MC_CHANNEL_2_CKE_TIMING

This register contains parameters that specify the CKE timings. All units are in DCLK.

Device: 4, 5, 6 Function: 0 Offset: 90h Access as a Dword			
Bit	Type	Reset Value	Description
31:22	RO		Reserved
21	RW	1	CsForCkeTransition This bit specifies if CS is to be asserted when CKE transition with PowerDown entry/exit and SelfRefresh exit.
20:11	RW	00..00b	tXSDLL This field provides the minimum delay between the exit of self refresh and commands that require a locked DLL.
10:3	RW	00..00b	tXS This field provides the minimum delay between the exit of self refresh and commands not requiring a DLL.
2:0	RW	000b	tCKE This field provides the CKE minimum pulse width.



2.11.5 MC_CHANNEL_0_CKE_TIMING_B MC_CHANNEL_1_CKE_TIMING_B MC_CHANNEL_2_CKE_TIMING_B

This register contains parameters that specify CKE timings.

Device: 4, 5, 6 Function: 0 Offset: 78h Access as a Dword			
Bit	Type	Reset Value	Description
31:15	RO		Reserved
14:5	RW	00..00b	tRANKIDLE The Rank will go into powerdown after it has been idle for the specified number of DCLKs. tRANKIDLE covers maximum (txxxPDEN). The minimum value is tWRAPDEN. If CKE is being shared between ranks, then both ranks must be idle for this amount of time. A Power Down Entry command will be requested for a rank after this number of DCLKs if no request to the rank is in the MC.
4:0	RW	00000b	tXP This field provides the minimum delay from exit power down with DLL and any valid command. Exit Precharge Power Down with DLL frozen to commands not requiring a locked DLL.

2.11.6 MC_CHANNEL_0_SCHEDULER_PARAMS MC_CHANNEL_1_SCHEDULER_PARAMS MC_CHANNEL_2_SCHEDULER_PARAMS

These are the parameters used to control parameters within the scheduler.

Device: 4, 5, 6 Function: 0 Offset: B8h Access as a Dword			
Bit	Type	Reset Value	Description
31:15	RO		Reserved
14	RW	0	DISABLE_8B_CRITICAL_WORD. Disable Critical Word First Optimization
13	RW	0	DDR_CLK_TRISTATE_DISABLE. 0 = DDR clock drivers will always be enabled. 1 = Disable
12	RW	0	CS_ODT_TRISTATE_DISABLE. 0 = CS and ODT drivers will be tristated when CKE=0 (power down and self refresh). 1 = CS and ODT drivers are always enabled.
11	RW	0	FLOAT_EN. When set to 1, the address and command lines will float to save power when commands are not being sent out. This setting may not work with RDIMMs.
10:6	RW	07h	PRECASRDTHRESHOLD. Threshold above which Medium-Low Priority reads can PRE-CAS write requests.
5	RW	0	DISABLE_ISOC_RBC_RESERVE. When set to 1, this bit will prevent any RBCs from being reserved for ISOC.
4	RO		Reserved
3	RW	0	ENABLE2N. Enable 2n Timing.
2:0	RW	000b	PRIORITYCOUNTER. This field provides the upper 3 MSB of the 8-bit priority time out counter.

2.11.7 MC_CHANNEL_0_PAGETABLE_PARAMS2 MC_CHANNEL_1_PAGETABLE_PARAMS2 MC_CHANNEL_2_PAGETABLE_PARAMS2

These are the parameters used to control parameters for page closing policies.

Device: 4, 5, 6 Function: 0 Offset: DCh Access as a Dword			
Bit	Type	Reset Value	Description
31:28	RO		Reserved
27	RW	0	ENABLEADAPTIVEPAGECLOSE When set to 1, this bit enables Adaptive Page Closing.
26:18	RW	00..00b	MINPAGECLOSELIMIT This field provides the upper 9 MSBs of a 13-bit threshold limit. When the mistake counter falls below this threshold, a less aggressive page close interval (larger) is selected.
17:9	RW	00..00b	MAXPAGECLOSELIMIT This field provides the upper 9 bits of a 13-bit threshold limit. When the mistake counter exceeds this threshold, a more aggressive page close interval (smaller) is selected.
8:0	RW	00..00b	MISTAKECOUNTER This field provides the upper 8 MSBs of a 12-bit counter. This counter adapts the interval between assertions of the page close flag. For a less aggressive page close, the length of the count interval is increased and vice versa for a more aggressive page close policy.

2.12 Memory Thermal Control

2.12.1 MC_THERMAL_STATUS0 MC_THERMAL_STATUS1 MC_THERMAL_STATUS2

Status registers for the thermal throttling logic for each channel.

Device: 4, 5, 6 Function: 3 Offset: 4Ch Access as a Dword			
Bit	Type	Reset Value	Description
31:30	RO		Reserved
29:4	RO	00..00b	CYCLES_THROTTLED This field provides the number of throttle cycles, in increments of 256 DCLKs, triggered in any rank in the last SAFE_INTERVAL number of ZQs.
3:0	RO	0000b	RANK_TEMP The bits 3:0 specify whether the throttler[3:0] is above throttling threshold.



2.12.2 MC_DDR_THERMO_COMMAND0 MC_DDR_THERMO_COMMAND1 MC_DDR_THERMO_COMMAND2

This register contains the command portion of the DDR_THERM# pin functionality (that is, what an assertion of the pin does).

Device: 4, 5, 6 Function: 3 Offset: 9Ch Access as a Dword			
Bit	Type	Reset Value	Description
31:4	RO		Reserved
3	RW	0	THROTTLER Force throttling when the DDR_THERM# pin is asserted.
2	RW	0	REF_2X Force 2x refresh as long as DDR_THERM# is asserted (low).
1	RW	0	DISABLE_EXTTS Response to the DDR_THERM# pin is disabled. ASSERTION and DEASSERTION fields in the MC_DDR_THERMO_STATUS register are frozen.
0	RW1S	0	LOCK When set to 1, all bits in this register are RO and cannot be written. Reset will clear the lock.

2.12.3 MC_DDR_THERM1_COMMAND0 MC_DDR_THERM1_COMMAND1 MC_DDR_THERM1_COMMAND2

This register contains the command portion of the DDR_THERM2# pin functionality (that is, what an assertion of the pin does).

Device: 4, 5, 6 Function: 3 Offset: A0h Access as a Dword			
Bit	Type	Reset Value	Description
31:4	RO		Reserved
3	RW	0	THROTTLER Force throttling when DDR_THERM# pin is asserted.
2	RW	0	Reserved
1	RW	0	DISABLE_EXTTS 1 = Response to DDR_THERM# pin is disabled. ASSERTION and DEASSERTION fields in the MC_DDR_THERM_STATUS register are frozen.
0	RW1S	0	LOCK. When set to 1, all bits in this register are RO and cannot be written. Reset will clear the lock.

2.12.4 MC_DDR_THERMO_STATUS0 MC_DDR_THERMO_STATUS1 MC_DDR_THERMO_STATUS2

This register contains the status portion of the DDR_THERM# pin functionality (that is, what is happening or has happened with respect to the pin).

Device: 4, 5, 6 Function: 3 Offset: A4h Access as a Dword			
Bit	Type	Reset Value	Description
31:3	RO		Reserved
2	RO	0	ASSERTION 1 = An assertion edge was seen on DDR_THERM#. Write 1 to clear this bit.
1	RO	0	DEASSERTION 1 = A de-assertion edge was seen on DDR_THERM#. Write 1 to clear this bit.
0	RO	0	STATE This bit provides the present logical state of DDR_THERM#. This is a static indication of the pin, and may be several clocks out of date due to the delay between the pin and the signal. 0 = DDR_THERM# is de-asserted 1 = DDR_THERM# is asserted

2.12.5 MC_DDR_THERM1_STATUS0 MC_DDR_THERM1_STATUS1 MC_DDR_THERM1_STATUS2

This register contains the status portion of the DDR_THERM2# pin functionality (that is, what is happening or has happened with respect to the pin).

Device: 4, 5, 6 Function: 3 Offset: A8h Access as a Dword			
Bit	Type	Reset Value	Description
31:3	RO		Reserved
2	RO	0	ASSERTION 1 = An assertion edge was seen on DDR_THERM#. Write 1 to clear this bit.
1	RO	0	DEASSERTION 1 = A de-assertion edge was seen on DDR_THERM#. Write 1 to clear this bit.
0	RO	0	STATE This bit provides the present logical state of DDR_THERM#. This is a static indication of the pin, and may be several clocks out of date due to the delay between the pin and the signal. 0 = DDR_THERM# is deasserted 1 = DDR_THERM# is asserted

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